



Product Change Notification

Change Notification #: 116828 - 00
Change Title: Intel® Storage System JBOD2312S3SP,
PCN 116828-00, Label,
Power supply logo change
Date of Publication: March 20, 2019

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:*	April 5, 2019
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following change on the Intel® Storage System JBOD2312S3SP 460W power supply.

1. Change on the BIS safety mark label to include the URL.
Logo Image



R-41061263
www.bis.gov.in

Label Pre-Change

	制造商: 台达电子工业股份有限公司 製造商: 台達電子工業股份有限公司 MFG.: DELTA ELECTRONICS, INC.	SWITCHING POWER SUPPLY 交換式電源供應器 开关电源 声明
AUTORANGE INPUT (自動調整輸入/自动调整输入): 50/60Hz INPUT (輸入/输入): 100-127V~/ 5.8A 200-240V~/ 2.9A		此为A级产品。在生活环境中, 该产品可能会造成无线电干扰 在这种情况下, 可能需要用户 对其干扰采取切实可行的措施 警告使用者:
OUTPUT (輸出/输出): 460W MAX. (最大輸出460W/最大輸出460W) +12V === / 38.0A +12VSB=== / 2.1A		這是甲類的資訊產品, 在居住的環境中使用時, 可能會造成射頻干擾, 在這種情況下, 使用者會被要求採取某些適當的對策。
		IS 13252 (Part 1) IEC 60950-1
MODEL (型號/型号): DPS-460KB A REV(版本): 04F		WARNING Connect only to a properly earth grounded outlet. Apparaten skall anslutas till jordat uttag. Laite on liitettävä suojamaadoituskoskettimilla varustettuun pistorasiaan. 僅能必須正確接地, 機身必須正確接地
P/N E98794-009		
S/N E98794XXXXXXXXXX		
MADE IN CHINA.(DCGP) (製造地: 中國/製造地: 中國)		

Label Post Change

	制造商: 台达电子工业股份有限公司 製造商: 台達電子工業股份有限公司 MFG.: DELTA ELECTRONICS, INC.	SWITCHING POWER SUPPLY 交換式電源供應器 开关电源 声明
AUTORANGE INPUT (自動調整輸入/自动调整输入): 50/60Hz INPUT (輸入/输入): 100-127V~/ 5.8A 200-240V~/ 2.9A		此为A级产品。在生活环境中, 该产品可能会造成无线电干扰 在这种情况下, 可能需要用户 对其干扰采取切实可行的措施 警告使用者:
OUTPUT (輸出/输出): 460W MAX. (最大輸出460W/最大輸出460W) +12V === / 38.0A +12VSB=== / 2.1A		這是甲類的資訊產品, 在居住的環境中使用時, 可能會造成射頻干擾, 在這種情況下, 使用者會被要求採取某些適當的對策。
		IS 13252 (Part 1) IEC 60950-1
MODEL (型號/型号): DPS-460KB A REV(版本): 05F		WARNING Connect only to a properly earth grounded outlet. Apparaten skall anslutas till jordat uttag. Laite on liitettävä suojamaadoituskoskettimilla varustettuun pistorasiaan. 僅能必須正確接地, 機身必須正確接地
P/N E98794-010		
S/N E98794XXXXXXXXXX		
MADE IN CHINA.(DCGP) (製造地: 中國/製造地: 中國)		

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from this change. Customers may need to validate the function and feature change once the post-change system is available.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
JBOD2312S3SP	939205	H54802-007	H54802-008

PCN Revision History:

Date of Revision:

March 20, 2019

Revision Number:

00

Reason:

Originally Published PCN



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116828 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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